



Material declaration form

General Information							
IPC	1752	Version	2				
Form type*	Distribute	Version	۷				
Sectionals*	Material information	Subsectionals*	A-D				
	Manufacturing information	*: Required Field					

Supplier Information							
Company name*	STMicroelectronics	Response Date*	2022-07-26				
Contact name*	Refer to Supplier Comment section		Refer to Supplier Comment section				
Contact phone*	Refer to Supplier Comment section Contact email*		Refer to Supplier Comment section				
Authorized representative*	Floriana SAN BIAGIO Representative title		AMS Material Declaration champion				
Representative phone*	Refer to Supplier Comment section	Representative email*	Refer to Supplier Comment section				
Supplier comment	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html						

Uncertainty statement

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Legal statement

 Supplier acceptance*
 true
 Legal declaration*
 Standard

 Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier

acknowledges that Company will rely on this certification in determination of the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this cartification in determination of the products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others in completing their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.



Product				
Mfr item number	Mfr item name	Version	Manufacturing site	date
	1D07*27025AW	A	64BA	2022-07-26
	Amount	Unit of measure	Unit type	ST ECOPACK grade
	77	mg	Each	ECOPACK® 3

Manufacturing information							
J-STD-020 MSL rating	Classification temperature Number of reflow cycles						
1	260 3						
Bulk solder termination	Terminal plating	Terminal base alloy	Comment				
Not Applicable	Tin (Sn), matte, annealed	Copper Alloy	,				
Package Designator	Package Size	Nbr of instances	Shape				
DSO	4.9 x 3.9	8	Gull wing				
Comment	DEC; MDF is valid for TS272AIDT and TS272ACD	T and TS272CDT					

life.augmented Material declaration form

ueryList : RoHS Directive 2011/65/EU- 8 June 2011 – Annex II amended by Delegated Directive 2015/863 - 31 March 2015 Response Response						
	Response					
1 - Product(s) meets EU RoHS requireme	true					
2 - Product(s) meets EU RoHS requireme apply)	false					
3 - Product(s) meets EU RoHS requireme	false					
4 - Product(s) does not meet EU RoHS re	false					
Exemption Id.	Description	-				

QueryList : California Prop65 list, dated 25th Feb 2022	Response					
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen						
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen						
Substance amount in product (mg) Application						
Nickel	0.000		0			
Lead	0.000		0			
Lead-Borate Glass	0.000		0			
Lead Zirconate Titanate	0.000		0			
Antimony trioxide	0.000		0			
Bisphenol A	0.000		0			

QueryList : REACH-10 Jun 2022	Response				
1 - Product(s) does not contain REACH S	true				
CategoryLevel_Name	egoryLevel_Name CategoryLevel_Threshold amount in product (mg) Application				
3					
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH					
tegoryLevel_Name CategoryLevel_Threshold		Amount in embedded article / Homogeneous material (mg)	Application - article / Homogeneous material	ppm in article /Homogeneous material	
3			,		

QueryList : Responsible metals sourcing	Response
The component is containing at least one of the following metals : Cobalt , Gold , Tantalum , Tin , Tungsten.	true
The following metals are present is the component :	Tin,

QueryList : Korea Chemical Control A	Response		
he Product does contain at least one of	false		

QueryList : China GB 33372-2020 Limit standard for volatile organic compounds content in adhesives - 4 March 2020 application date 1st December 2020	Response
The product contains adhesives identified under GB 33372	true
All the adhesive impacted complies with GB 33372	true

Stockholm Convention Persistent Organic Pollutants	Response
Product is compliant with Stockholm Convention Persistent Organic Pollutants Annex I	false

ACTIVE: 26/07/2022

Material Composition Declaration : note : Substance present with less 0.001mg will not be declared in this document			Mfr Item Name	1[007*27025AW	76.2740		500000.0	997045.0			
Homogeneous material	Material group	Mass	Unit of measure	Level	Substance category	Substance	CAS	Exempt	Mass	Unit of measure	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die	M-011 Other inorganic materials	1.566	mg	supplier	die	Silicon(Si)	7440-21-3		1.527	mg	975096	19961
				supplier	metallisation	Aluminium(AI)	7429-90-5		0.006	mg	3831	78
				supplier	Passivation	Silicon nitride(SiN)	12033-89-5		0.004	mg	2554	52
				supplier	passivation	Silicon oxide	7631-86-9		0.029	mg	18519	379
Leadframe	M-004 Copper and its alloys	28.765	mg	supplier	alloy	Copper(Cu)	7440-50-8		27.987	mg	972953	365843
				supplier	alloy	Iron(Fe)	7439-89-6		0.658	mg	22875	8601
				supplier	alloy	Iron phosphide	1310-43-6		0.040	mg	1391	523
				supplier	alloy	Zinc(Zn)	7440-66-6		0.035	mg	1217	458
				supplier	metallization	Silver (Ag)	7440-22-4		0.045	mg	1564	588
Bonding wires	M-004 Copper and its alloys	0.044	mg	supplier	wire	Copper(Cu)	7440-50-8		0.044	mg	1000000	575
Encapsulation	M-015 Other organic materials	45.181	mg	supplier	mold compound	Silica vitreous	60676-86-0		32.349	mg	715987	422863
				supplier	mold compound	Silicon oxide	7631-86-9		6.777	mg	149997	88588
				supplier	mold compound	Biphenyl epoxy resin	85954-11-6		3.389	mg	75009	44301
				supplier	mold compound	Phenol resin	26834-02-6		2.259	mg	49999	29529
				supplier	mold compound	Carbon black	1333-86-4		0.226	mg	5002	2954
				supplier	mold compound	Bismuth compound	7440-69-9		0.181	mg	4006	2366
Connections coating	Solder	0.718	mg	supplier	solder alloy	Tin (Sn)	7440-31-5		0.718	mg	1000000	9386